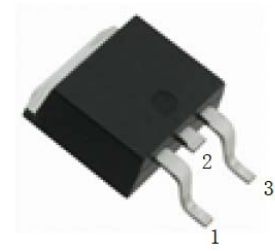
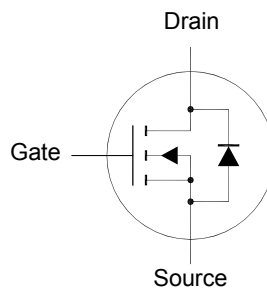


SFTN5038R

N-Channel Enhancement Mode MOSFET



1.Gate 2.Drain 3.Source
TO-252 Plastic Package

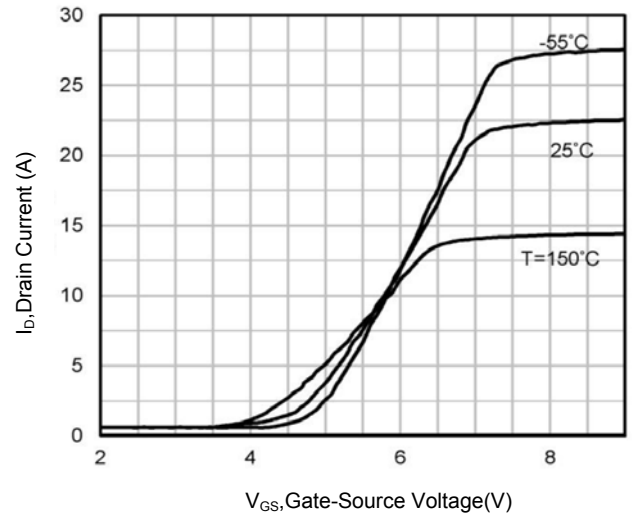
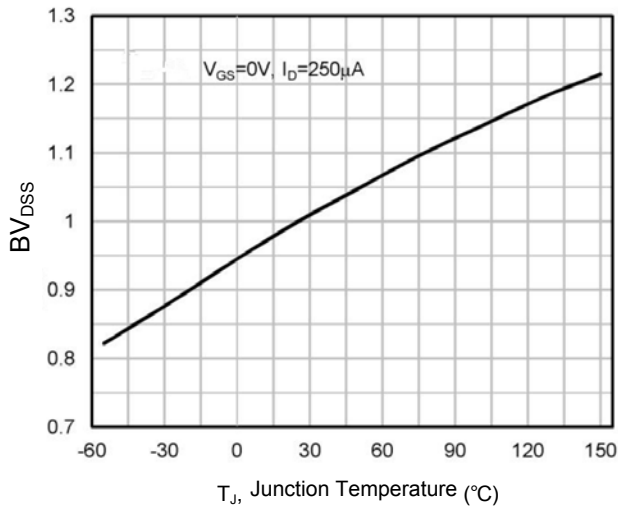
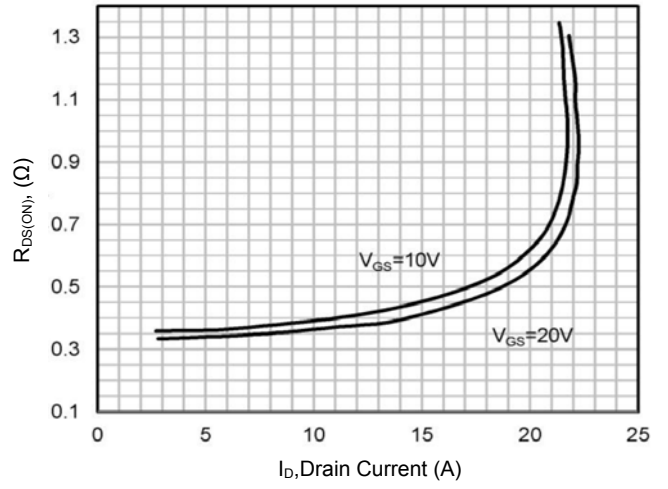
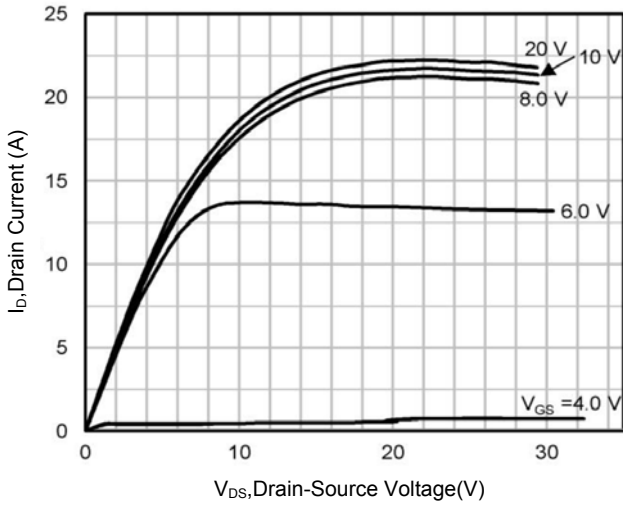
Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current	I_D	$T_C = 25^\circ\text{C}$ 11 $T_C = 100^\circ\text{C}$ 6.95	A
Pulsed Drain Current	I_{DM}	33	A
Power Dissipation	P_D	$T_C = 25^\circ\text{C}$ 83	W
Avalanche energy, single pulse	E_{AS}	220	mJ
Maximum Thermal Resistance from Junction to Case	$R_{\theta JC}$	1.5	$^\circ\text{C/W}$
Maximum Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 55 to + 150	$^\circ\text{C}$

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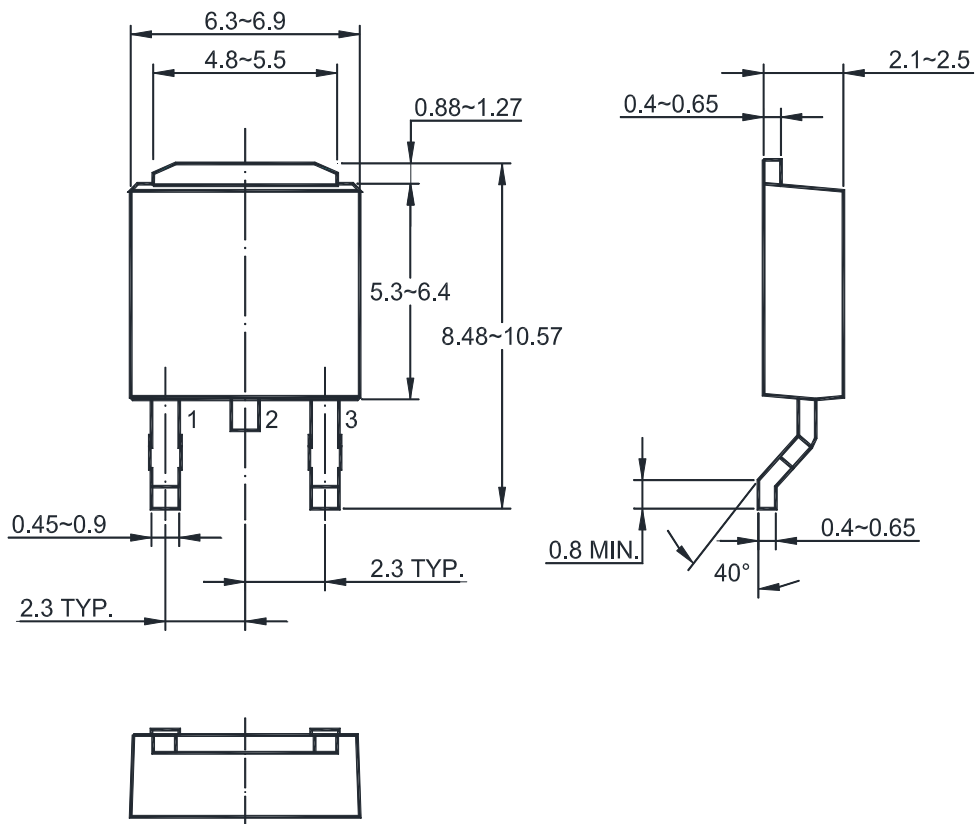
Characteristics at Ta = 25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 250 \mu\text{A}$	BV_{DSS}	500	-	-	V
Drain-Source Leakage Current at $V_{DS} = 500 \text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 30 \text{ V}$	I_{GSS}	-	-	100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	$V_{GS(th)}$	2.5	-	3.5	V
Drain-Source On-State Resistance at $V_{GS} = 10 \text{ V}, I_D = 3.8 \text{ A}$	$R_{DS(on)}$	-	-	380	m Ω
Input Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{iss}	-	702	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{oss}	-	357	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{rss}	-	33.7	-	pF
Turn-On Delay Time at $V_{DD} = 250 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}, R_G = 25 \Omega$	$t_{d(on)}$	-	15.2	-	nS
Turn-On Rise Time at $V_{DD} = 250 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}, R_G = 25 \Omega$	t_r	-	32	-	nS
Turn-Off Delay Time at $V_{DD} = 250 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}, R_G = 25 \Omega$	$t_{d(off)}$	-	59.6	-	nS
Turn-Off Fall Time at $V_{DD} = 250 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}, R_G = 25 \Omega$	t_f	-	28.4	-	nS
Drain-Source Diode Forward Voltage at $I_{SD} = 11 \text{ A}$	V_{SD}	-	-	1.4	V



Package Outline Dimensions (Units: mm)

TO-252



Recommended Soldering Footprint

